

Thermal Characteristics

Repetitive Avalanche Energy

Power Dissipation ($T_A = 25^{\circ}C$) *

Power Dissipation ($T_C = 25^{\circ}C$)

1/8" from case for 5 seconds

- Derate above 25°C

Maximum lead temperature for soldering purposes,

Operating and Storage Temperature Range

Peak Diode Recovery dv/dt

Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		5.0	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		50	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		110	°C/W

(Note 1)

(Note 3)

2.5

-6.0

2.5

25

0.2

-55 to +150

300

 E_{AR}

dv/dt

T_J, T_{STG}

 P_D

 T_L

mJ

V/ns

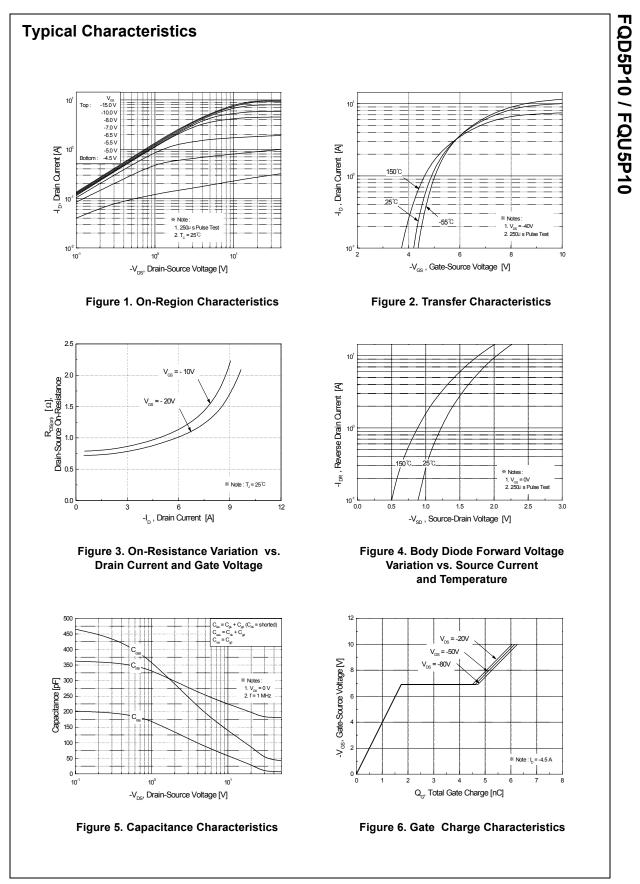
W

W W/°C

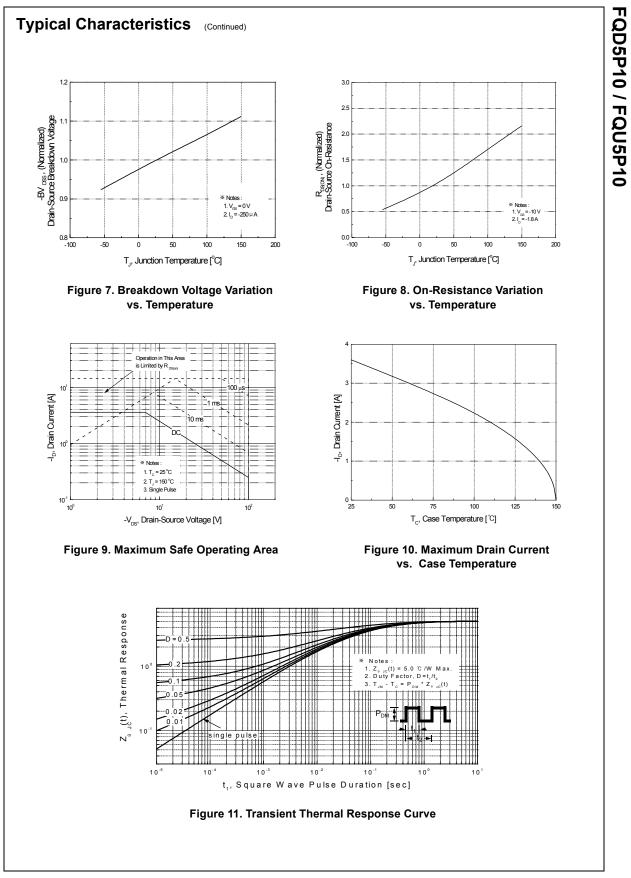
°C

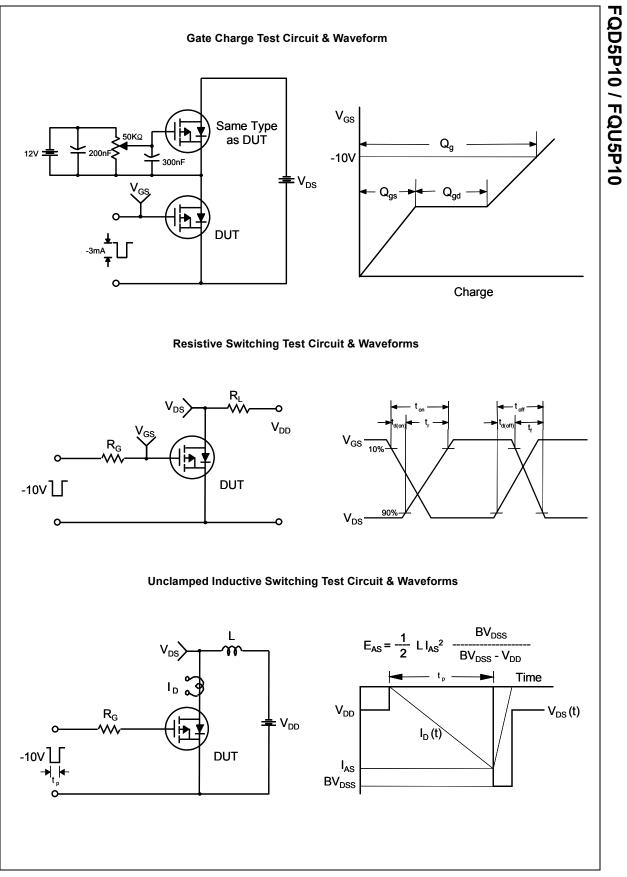
°C

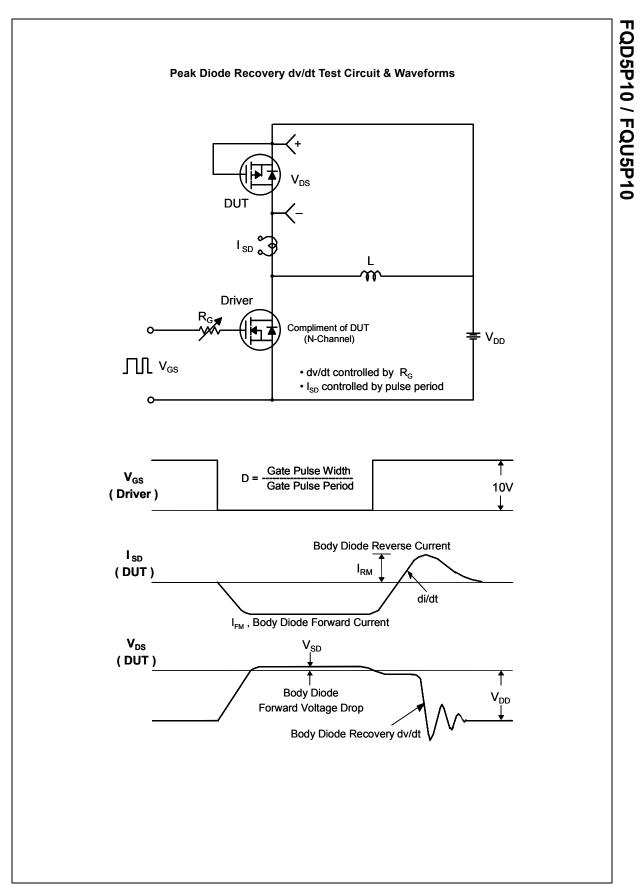
Symbol	Parameter	Test Conditions		Min	Тур	Мах	Units
Off Cha	racteristics						
3V _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0 V, I _D = -250 μA		-100			V
ΔBV _{DSS} ΔT _J	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu A$, Referenced	to 25°C		-0.1		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = -100 V, V _{GS} = 0 V				-1	μA
		V _{DS} = -80 V, T _C = 125°C				-10	μA
GSSF	Gate-Body Leakage Current, Forward	V _{GS} = -30 V, V _{DS} = 0 V				-100	nA
GSSR	Gate-Body Leakage Current, Reverse	V_{GS} = 30 V, V_{DS} = 0 V				100	nA
On Cha	racteristics						
/ _{GS(th)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = -250 μA		-2.0		-4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{GS} = -10 \text{ V}, \text{ I}_{D} = -1.8 \text{ A}$			0.82	1.05	Ω
ĴFS	Forward Transconductance	V _{DS} = -40 V, I _D = -1.8 A	(Note 4)		2.3		S
Dynami	c Characteristics						
Siss	Input Capacitance	V _{DS} = -25 V, V _{GS} = 0 V,			190	250	pF
C _{oss}	Output Capacitance	f = 1.0 MHz			70	90	pF
C _{rss}	Reverse Transfer Capacitance				18	25	pF
Switchi	ng Characteristics						
d(on)	Turn-On Delay Time	V _{DD} = -50 V, I _D = -4.5 A,		-	9	30	ns
r	Turn-On Rise Time	$R_{\rm G} = 25 \Omega$			70	150	ns
d(off)	Turn-Off Delay Time				12	35	ns
f	Turn-Off Fall Time	(Note 4, 5)		30	70	ns
ζ ^g	Total Gate Charge	V _{DS} = -80 V, I _D = -4.5 A,			6.3	8.2	nC
ג gs	Gate-Source Charge	V _{GS} = -10 V			1.7		nC
ጋ _{gd}	Gate-Drain Charge	(Note 4, 5)		3.0		nC
)rain-S	ource Diode Characteristics a	nd Maximum Ratings					
s	ource Diode Characteristics and Maximum Ratings Maximum Continuous Drain-Source Diode Forward Current					-3.6	A
SM	Maximum Pulsed Drain-Source Diode F	Forward Current				-14.4	Α
/ _{SD}	Drain-Source Diode Forward Voltage	V_{GS} = 0 V, I _S = -3.6 A				-4.0	V
rr	Reverse Recovery Time	V _{GS} = 0 V, I _S = -4.5 A,			85		ns
ე ["]	Reverse Recovery Charge	dI _F / dt = 100 A/µs	(Note 4)		0.27		μC
L = 6.4mH, I I _{SD} ≤ -4.5A, Pulse Test :	ating : Pulse width limited by maximum junction tempe $A_S = {}^{-3.6A}$, $V_{DD} = {}^{-25V}$, $R_G = {}^{25} \Omega$, Starting $T_J = {}^{25^\circ}C$ di/dt $\leq 300A/\mu s$, $V_{DD} \leq BV_{DSS}$, Starting $T_J = {}^{25^\circ}C$ Pulse width $\leq 300 \mu s$, Duty cycle $\leq 2\%$ ndependent of operating temperature						

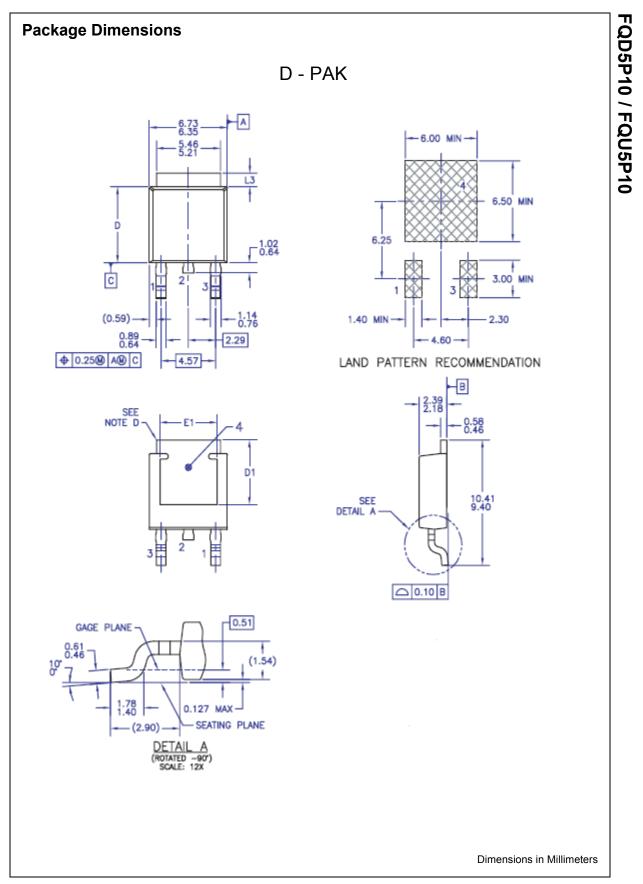


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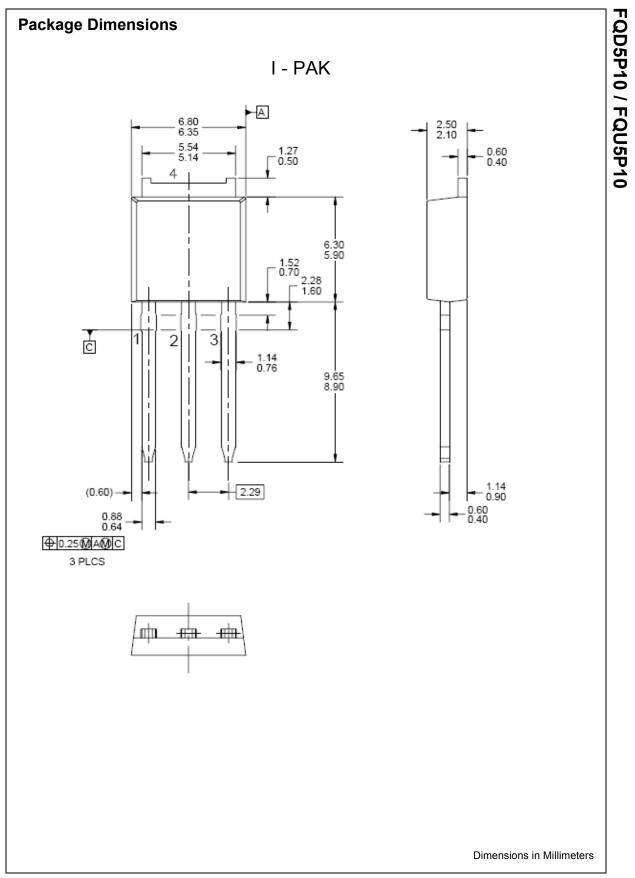








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